SCLS399A - APRIL 1998 - REVISED AUGUST 1998

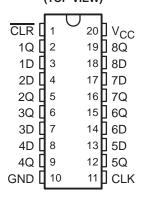
- EPIC™ (Enhanced-Performance Implanted CMOS) Process
- Typical V<sub>OLP</sub> (Output Ground Bounce)
  < 0.8 V at V<sub>CC</sub>, T<sub>A</sub> = 25°C
- Typical V<sub>OHV</sub> (Output V<sub>OH</sub> Undershoot)
  2 V at V<sub>CC</sub>, T<sub>A</sub> = 25°C
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Package Options Include Plastic Small-Outline (DW, NS), Shrink Small-Outline (DB), Thin Very Small-Outline (DGV), and Thin Shrink Small-Outline (PW) Packages, Ceramic Flat (W) Packages, Chip Carriers (FK), and DIPs (J)

#### description

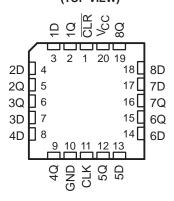
The 'LV273A devices are octal D-type flip-flops designed for 2-V to 5.5-V V<sub>CC</sub> operation.

These devices are positive-edge-triggered flip-flops with direct clear (CLR) input. Information at the data (D) inputs meeting the setup time requirements is transferred to the Q outputs on the positive-going edge of the clock pulse. Clock triggering occurs at a particular voltage level and is not directly related to the transition time of the

SN54LV273A . . . J OR W PACKAGE SN74LV273A . . . DB, DGV, DW, NS, OR PW PACKAGE (TOP VIEW)



### SN54LV273A . . . FK PACKAGE (TOP VIEW)



positive-going pulse. When the clock (CLK) input is at either the high or low level, the D-input signal has no effect at the output.

The SN54LV273A is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74LV273A is characterized for operation from –40°C to 85°C.

### FUNCTION TABLE (each flip-flop)

	INPUTS		OUTPUT
CLR	CLK	D	Q
L	Х	Χ	L
Н	$\uparrow$	Н	Н
Н	$\uparrow$	L	L
Н	L	Χ	Q <sub>0</sub>

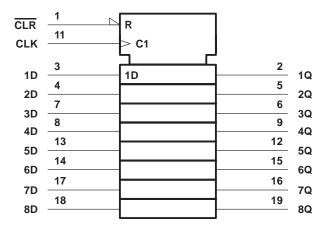


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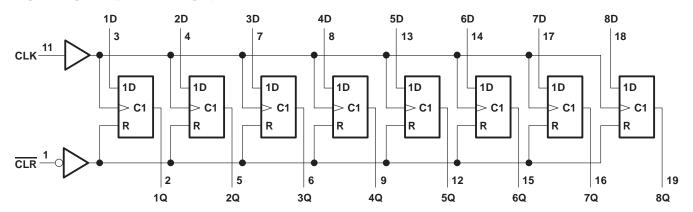


### logic symbol†



<sup>&</sup>lt;sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

### logic diagram (positive logic)





#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V <sub>CC</sub>		0.5 V to 7 V
Input voltage range, V <sub>I</sub> (see Note 1)		0.5 V to 7 V
Output voltage range, VO (see Notes 1 and 2)		-0.5 V to V <sub>CC</sub> + 0.5 V
Input clamp current, $I_{IK}$ ( $V_I < 0$ )		–20 mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CO}$	c)	±50 mA
Continuous output current, $I_O(V_O = 0 \text{ to } V_{CC})$	·····	±25 mA
Continuous current through V <sub>CC</sub> or GND		±50 mA
Package thermal impedance, $\theta_{JA}$ (see Note 3):		
<b>371</b>	DGV package	
	DW package	97°C/W
	NS package	100°C/W
	PW package	128°C/W
Storage temperature range, T <sub>stg</sub>		–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

- 2. This value is limited to 7 V maximum.
- 3. The package thermal impedance is calculated in accordance with JESD 51.

### recommended operating conditions (see Note 4)

			SN54LV	273A	SN74L\	/273A	UNIT
			MIN	MAX	MIN	MAX	ONII
Vcc	Supply voltage		2	5.5	2	5.5	V
		V <sub>CC</sub> = 2 V	1.5		1.5		
\ <i>/</i>	High lovel input valtage	V <sub>CC</sub> = 2.3 V to 2.7 V	V <sub>CC</sub> ×0.7		V <sub>CC</sub> ×0.7		V
VIH	High-level input voltage	V <sub>CC</sub> = 3 V to 3.6 V	V <sub>CC</sub> ×0.7		V <sub>CC</sub> × 0.7		]
		V <sub>CC</sub> = 4.5 V to 5.5 V	V <sub>CC</sub> ×0.7		V <sub>CC</sub> × 0.7		]
		V <sub>CC</sub> = 2 V		0.5		0.5	
\/	Low-level input voltage	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	V	CC × 0.3	V	CC×0.3	V
$V_{IL}$	Low-level input voltage	V <sub>CC</sub> = 3 V to 3.6 V	V	CC × 0.3	V	CC×0.3	ľ
		V <sub>CC</sub> = 4.5 V to 5.5 V	V	CC × 0.3	V	CC×0.3	
VI	Input voltage		0	5.5	0	5.5	V
٧o	Output voltage		0	Vcc	0	Vcc	V
		V <sub>CC</sub> = 2 V		<del>-</del> 50		-50	μΑ
lou	High-level output current	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	4	<b>-</b> 2		-2	
ЮН	r light-level output current	$V_{CC} = 3 \text{ V to } 3.6 \text{ V}$	Ú	-6		-6	mA
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	20	-12		-12	
		V <sub>CC</sub> = 2 V	SP C	50		50	μΑ
lai	Low-level output current	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		2		2	
lOL	Low-level output current	$V_{CC} = 3 \text{ V to } 3.6 \text{ V}$		6		6	mA
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		12		12	
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	0	200	0	200	
$\Delta t/\Delta v$	Input transition rise or fall rate	$V_{CC} = 3 V \text{ to } 3.6 V$	0	100	0	100	ns/V
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	0	20	0	20	
TA	Operating free-air temperature		-55	125	-40	85	°C

NOTE 4: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	.,	SN54LV273A	SN74LV273A	UNIT
PARAMETER	TEST CONDITIONS	VCC	MIN TYP MAX	MIN TYP MAX	UNII
	I <sub>OH</sub> = -50 μA	2 V to 5.5 V	V <sub>CC</sub> -0.1	V <sub>CC</sub> -0.1	
Vou	$I_{OH} = -2 \text{ mA}$	2.3 V	2	2	V
VOH	I <sub>OH</sub> = -6 mA	3 V	2.48	2.48	V
	I <sub>OH</sub> = -12 mA	4.5 V	3.8	3.8	
	I <sub>OL</sub> = 50 μA	2 V to 5.5 V	0.1	0.1	
Val	I <sub>OL</sub> = 2 mA	2.3 V	0.4	0.4	V
VOL	I <sub>OL</sub> = 6 mA	3 V	0.44	0.44	v
	I <sub>OL</sub> = 12 mA	4.5 V	0.55	0.55	
lį	$V_I = V_{CC}$ or GND	5.5 V		±1	μΑ
ICC	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V	20	20	μΑ
l <sub>off</sub>	$V_I$ or $V_O = 0$ to 5.5 $V$	0 V	5	5	μΑ
Ci	V <sub>I</sub> = V <sub>CC</sub> or GND	3.3 V	2	2	pF

# timing requirements over recommended operating free-air temperature range, $V_{CC}$ = 2.5 V $\pm$ 0.2 V (unless otherwise noted) (see Figure 1)

			T <sub>A</sub> = 2	25°C	SN54L	/273A	SN74L\	/273A	UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	UNIT
	Pulse duration	CLR low	6.5		7	4	7		no
t <sub>W</sub>	ruise duration	CLK high or low	7		8.5	2011	8.5		ns
	Output the state had an OUK	Data	8.5		10.5	11/2	10.5		no
t <sub>su</sub>	Setup time, data before CLK↑	CLR inactive	4		4		4		ns
th	Hold time, data after CLK↑		0.5		1		1		ns

# timing requirements over recommended operating free-air temperature range, $V_{CC}$ = 3.3 V $\pm$ 0.3 V (unless otherwise noted) (see Figure 1)

			T <sub>A</sub> = 2	25°C	SN54L	V273A	SN74L	/273A	UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	UNIT
	Pulse duration	CLR low	5		6	4	6		no
t <sub>W</sub>	ruise duiation	CLK high or low	5		6.5	100	6.5		ns
		Data	5.5		6.5	11/2	6.5		no
tsu	Setup time, data before CLK↑	CLR inactive	2.5		2.5		2.5		ns
t <sub>h</sub>	Hold time, data after CLK↑		1		1		1		ns

## timing requirements over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

			T <sub>A</sub> = :	25°C	SN54L	V273A	SN74L	V273A	UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	UNIT
	Pulse duration	CLR low	5		5		5		
t <sub>W</sub>	ruise duration	CLK high or low	5		5	100	5		ns
		Data	4.5		4.5	1115	4.5		
t <sub>su</sub>	Setup time, data before CLK↑	CLR inactive	2		2		2		ns
th	Hold time, data after CLK↑		1		1		1		ns

# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 2.5 V $\pm$ 0.2 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	LOAD	T,	4 = 25°C	;	SN54L	/273A	SN74L\	/273A	UNIT
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
4			C <sub>L</sub> = 15 pF*	55	95		45		45		MHz
†max			C <sub>L</sub> = 50 pF	45	75		40	4	40		IVIIIZ
tpd*	CLK	Q	C <sub>L</sub> = 15 pF		10.4	18.3	10	20.5	1	20.5	no
tPHL*	CLR	Q	CL = 15 pr		10.3	19	Q-14	21	1	21	ns
<sup>t</sup> pd	CLK	Q			12.9	22.1	<b>1</b>	25	1	25	
<sup>t</sup> PHL	CLR	Q	C <sub>L</sub> = 50 pF		13.1	22.8	1	25.5	1	25.5	ns
t <sub>sk(o)</sub> †						2				2	

<sup>\*</sup> On products compliant to MIL-PRF-38535, this parameter is not production tested.

## switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 3.3 V $\pm$ 0.3 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	LOAD	T,	Δ = 25°C	;	SN54L	V273A	SN74L	/273A	UNIT
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
f			C <sub>L</sub> = 15 pF*	75	140		65		65		MHz
<sup>T</sup> max			C <sub>L</sub> = 50 pF	50	110		45	4	45		IVITIZ
<sup>t</sup> pd*	CLK	Q	C 15 pE		7.1	13.6	10	16	1	16	ns
tPHL*	CLR	Q	C <sub>L</sub> = 15 pF		6.9	13.6	1	16	1	16	115
<sup>t</sup> pd	CLK	Q			9.1	17.1	<b>Q</b> 1	19.5	1	19.5	
<sup>t</sup> PHL	CLR	Q	C <sub>L</sub> = 50 pF		8.7	17.1	1	19.5	1	19.5	ns
t <sub>sk(o)</sub> †						1.5				1.5	

<sup>\*</sup> On products compliant to MIL-PRF-38535, this parameter is not production tested.



<sup>†</sup> Skew between any two outputs of the same package switching in the same direction

<sup>†</sup> Skew between any two outputs of the same package switching in the same direction

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## switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	LOAD	T,	λ = 25°C	;	SN54LV	/273A	SN74L\	/273A	UNIT
FARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN	MAX	MIN	MAX	ONIT
f			C <sub>L</sub> = 15 pF*	120	205		100		100		MHz
fmax			C <sub>L</sub> = 50 pF	80	160		70	4	70		IVITIZ
<sup>t</sup> pd*	CLK	Q	C <sub>I</sub> = 15 pF		4.8	9	10	10.5	1	10.5	ns
tPHL*	CLR	Q	CL = 15 pr		4.7	8.5	P-14	10	1	10	115
<sup>t</sup> pd	CLK	Q			6.2	11	<b>Q</b> 1	12.5	1	12.5	
<sup>t</sup> PHL	CLR	Q	$C_L = 50 pF$		6	10.5	1	12	1	12	ns
t <sub>sk(o)</sub> †						1				1	

<sup>\*</sup> On products compliant to MIL-PRF-38535, this parameter is not production tested.

### noise characteristics, $V_{CC}$ = 3.3 V, $C_L$ = 50 pF, $T_A$ = 25°C (see Note 5)

	PARAMETER	SN'	74LV273	BA	UNIT
	PARAMETER	MIN	TYP	MAX	UNIT
V <sub>OL(P)</sub>	Quiet output, maximum dynamic VOL		0.39	0.8	V
V <sub>OL</sub> (V)	Quiet output, minimum dynamic V <sub>OL</sub>		-0.36	-0.8	V
V <sub>OH(V)</sub>	Quiet output, minimum dynamic V <sub>OH</sub>		2.92		V
V <sub>IH(D)</sub>	High-level dynamic input voltage	2.31			V
V <sub>IL(D)</sub>	Low-level dynamic input voltage			0.99	V

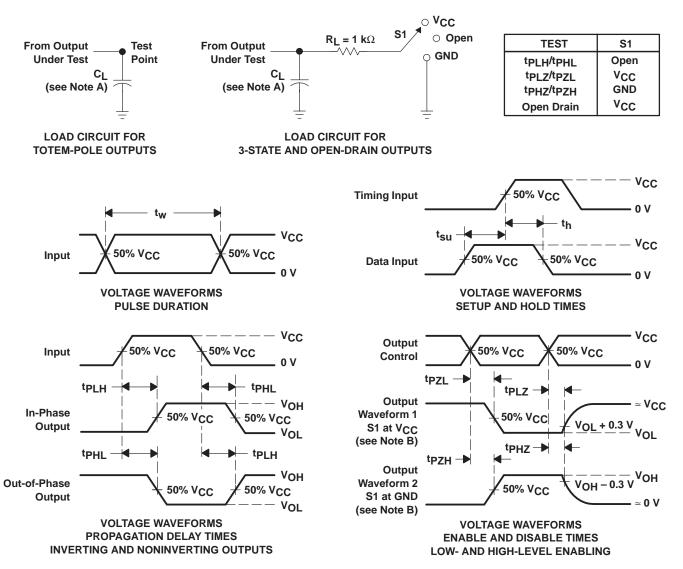
NOTE 5: Characteristics are for surface-mount packages only.

#### operating characteristics, T<sub>A</sub> = 25°C

		PARAMETER	TEST CONDITIONS	VCC	TYP	UNIT
Γ	Cara	Power dissipation capacitance	C <sub>1</sub> = 50 pF, f = 10 MHz	3.3 V	15.9	pF
L	Cpd	Tower dissipation capacitance	CL = 50 pr, T = 10 MHZ	5 V	17.1	ρī

<sup>†</sup> Skew between any two outputs of the same package switching in the same direction

#### PARAMETER MEASUREMENT INFORMATION



NOTES: A.  $C_L$  includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz,  $Z_Q = 50 \Omega$ ,  $t_f \leq 3$  ns,  $t_f \leq 3$  ns.
- D. The outputs are measured one at a time with one input transition per measurement.
- E. tpLz and tpHz are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G.  $t_{PHL}$  and  $t_{PLH}$  are the same as  $t_{pd}$ .

Figure 1. Load Circuit and Voltage Waveforms

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